



**12500 TI Boulevard, MS 8640, Dallas, Texas 75243**

**PCN# 20250417002.2**  
**Adding TIEM-PR as additional wafer probe test site**  
**for select devices**  
**Change Notification / Sample Request**

**Date:** April 17, 2025  
**To:** MOUSER PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within 60 days of the date of this notice. Lack of acknowledgement of this notice within 60 days constitutes acceptance and approval of this change. If samples or additional data are required, requests must be received within 60 days of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the change management team.

For sample requests or sample related questions, contact your local Field Sales Representative.

TI values customer engagement and feedback related to TI changes. Customers should contact TI if there are questions or concerns regarding a change notification.

Sincerely,

Change Management Team  
SC Business Services

**20250417002.2**  
**Change Notification / Sample Request**  
**Attachments**

**Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, you have recently purchased these devices. The corresponding customer part number is also listed, if available.

<b>DEVICE</b>	<b>CUSTOMER PART NUMBER</b>
ISO7742QDBQRQ1	ISO7742QDBQRQ1
ISO6763FQDWRQ1	NULL
ISO6762FQDWRQ1	NULL
ISO6762QDWRQ1	NULL
ISO7762QDBQRQ1	NULL
ISO7761QDBQRQ1	NULL
ISO7742FQDBQRQ1	NULL
ISO7720QDWVRQ1	NULL
ISO7721FQDWVRQ1	NULL
ISO7761FQDBQRQ1	NULL
ISO7760FQDBQRQ1	NULL
ISO6761QDWRQ1	NULL
ISO7762FQDBQRQ1	NULL
ISO7720FQDWVRQ1	NULL
ISO7731QDBQRQ1	ISO7731QDBQRQ1
ISO7741FQDBQRQ1	ISO7741FQDBQRQ1
ISO7720FQDRQ1	ISO7720FQDRQ1
ISO6720QDWVRQ1	NULL
ISO6721QDWVRQ1	NULL
ISO7720QDRQ1	ISO7720QDRQ1
ISO7721FQDRQ1	ISO7721FQDRQ1
ISO7721QDRQ1	ISO7721QDRQ1
ISO7763FQDBQRQ1	NULL
ISO7740FQDBQRQ1	595-ISO7740FQDBQRQ1
ISO7721QDWVRQ1	NULL
ISO6720FQDWVRQ1	NULL
ISO6721FQDWVRQ1	NULL
ISO7763QDBQRQ1	NULL
ISO7741QDBQRQ1	ISO7741QDBQRQ1
ISO7731FQDBQRQ1	ISO7731FQDBQRQ1

Technical details of this Product Change follow on the next page(s).

<b>PCN Number:</b>	20250417002.2			<b>PCN Date:</b>	April 17, 2025
<b>Title:</b>	Adding TIEM-PR as additional wafer probe test site for select devices				
<b>Customer Contact:</b>	Change Management team		<b>Dept:</b>	Quality Services	
<b>Proposed 1<sup>st</sup> Ship Date:</b>	October 14, 2025		<b>Estimated Sample Availability:</b>	N/A	
<b>Change Type:</b>					
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design	<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>	Assembly Process	<input type="checkbox"/>	Data Sheet	<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change	<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>	Mechanical Specification	<input checked="" type="checkbox"/>	Test Site	<input type="checkbox"/>	Wafer Fab Material
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process	<input type="checkbox"/>	Wafer Fab Process
<b>PCN Details</b>					
<b>Description of Change:</b>					
Texas Instruments is pleased to announce TIEM-PR as additional wafer probe test site for the devices listed below to support high volume ramps.					
		<b>Current</b>		<b>New</b>	
Probe Test Site		TI CDAT (CD-PR)		TI Melaka (TIEM-PR)	
Test coverage, insertions, conditions will remain consistent with current testing.					
<b>Reason for Change:</b>					
Continuity of supply.					
<b>Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):</b>					
None					
<b>Impact on Environmental Ratings:</b>					
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.					
<b>RoHS</b>		<b>REACH</b>		<b>Green Status</b>	
<input checked="" type="checkbox"/> No Change		<input checked="" type="checkbox"/> No Change		<input checked="" type="checkbox"/> No Change	
<b>Changes to product identification resulting from this PCN:</b>					
None					
<b>Product Affected:</b>					
ISO6721QDWVRQ1	ISO7762QDBQRQ1	ISO6520QDRQ1			
ISO7721QDWVRQ1	ISO6761FQDWRQ1	ISO7731FQDBQRQ1			
ISO6720QDWVRQ1	ISO6763QDWRQ1	ISO7720QDRQ1			
ISO7741QDBQRQ1	ISO7761FQDBQRQ1	ISO7720FQDWVRQ1			
ISO7760QDBQRQ1	ISO7763QDBQRQ1	ISO7721QDRQ1			
ISO7740FQDBQRQ1	ISO7721FQDRQ1	ISO7760FQDBQRQ1			
ISO7730QDBQRQ1	ISO6762QDWRQ1	ISO6520FQDRQ1			
ISO6521FQDRQ1	ISO6760QDWRQ1	ISO7763FQDBQRQ1			
ISO6521QDRQ1	ISO6762FQDWRQ1	ISO7742FQDBQRQ1			
ISO6721FQDWVRQ1	ISO7742QDBQRQ1	ISO6763FQDWRQ1			
ISO7721FQDWVRQ1	ISO7730FQDBQRQ1	ISO7741FQDBQRQ1			
ISO7720QDWVRQ1	ISO7731QDBQRQ1	ISO7740QDBQRQ1			
ISO6720FQDWVRQ1	ISO7720FQDRQ1	ISO6761QDWRQ1			
ISO7761QDBQRQ1	ISO7762FQDBQRQ1	ISO6760FQDWRQ1			

**ZVEI ID: SEM-TF-01**

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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